

# Silicon Power Schottky Diode

**V<sub>RRM</sub> = 20 V - 40 V**  
**I<sub>F</sub> = 25 A**

## Features

- High Surge Capability
- Types up to 40V V<sub>RRM</sub>

**DO-4 Package**



**Maximum ratings, at T<sub>j</sub> = 25 °C, unless otherwise specified ("R" devices have leads reversed)**

Parameter	Symbol	Conditions	1N5829 (R)	1N5830 (R)	1N5831 (R)	Unit
Repetitive peak reverse voltage	V <sub>RRM</sub>		20	25	35	V
RMS reverse voltage	V <sub>RMS</sub>		14	17	25	V
DC blocking voltage	V <sub>DC</sub>		20	25	35	V
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> ≤ 100 °C	25	25	25	A
Surge non-repetitive forward current, Half Sine Wave	I <sub>F,SM</sub>	T <sub>C</sub> = 25 °C, t <sub>p</sub> = 8.3 ms	800	800	800	A
Operating temperature	T <sub>j</sub>		-55 to 150	-55 to 150	-55 to 150	°C
Storage temperature	T <sub>stg</sub>		-55 to 175	-55 to 175	-55 to 175	°C

**Electrical characteristics, at T<sub>j</sub> = 25 °C, unless otherwise specified**

Parameter	Symbol	Conditions	1N5829 (R)	1N5830 (R)	1N5831 (R)	Unit
Diode forward voltage	V <sub>F</sub>	I <sub>F</sub> = 25 A, T <sub>j</sub> = 25 °C	0.58	0.58	0.58	V
Reverse current	I <sub>R</sub>	V <sub>R</sub> = 20 V, T <sub>j</sub> = 25 °C V <sub>R</sub> = 20 V, T <sub>j</sub> = 125 °C	2 250	2 250	2 250	mA

## Thermal characteristics

Thermal resistance, junction - case	R <sub>thJC</sub>	1.8	1.8	1.8	°C/W
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